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FQB8N60C / FQI8N60C N-Channel QFET[®] MOSFET 600 V, 7.5 A, 1.2 Ω

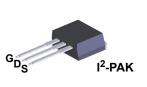
Description

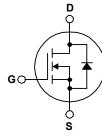
This N-Channel enhancement mode power MOSFET is • Low Gate Charge (Typ. 28 nC) produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • 100% Avalanche Tested resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- + 7.5 A, 600 V, $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ = 1.2 Ω (Max.) @ V_{GS} = 10 V, I_D = 3.75 A
- Low Crss (Typ. 12 pF)
- · RoHS Compliant







Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter Drain-Source Voltage		FQB8N60CTM / FQI8N60CTU	Unit
V _{DSS}			600	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		7.5	А
	- Continuous (T _C = 100°C)		4.6	А
I _{DM}	Drain Current - Pulsed	(Note 1)	30	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy (N		230	mJ
I _{AR}	Avalanche Current	(Note 1)	7.5	A mJ
E _{AR}	Repetitive Avalanche Energy	(Note 1)	14.7	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
	Power Dissipation (T _A = 25°C)*	3.13	W	
P _D	Power Dissipation ($T_C = 25^{\circ}C$)	147	W	
	- Derate above 25°C	1.18	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds.	300	°C	

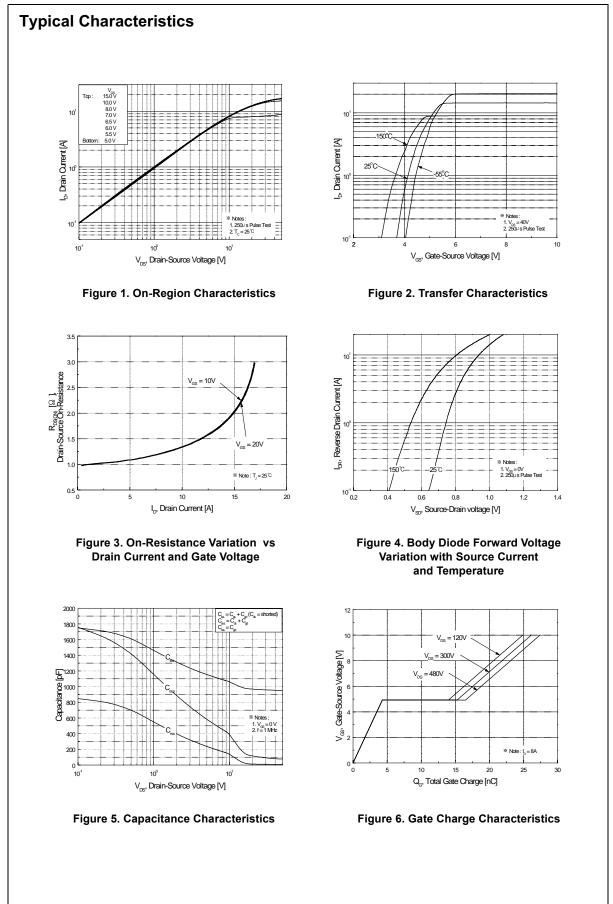
Thermal Characteristics

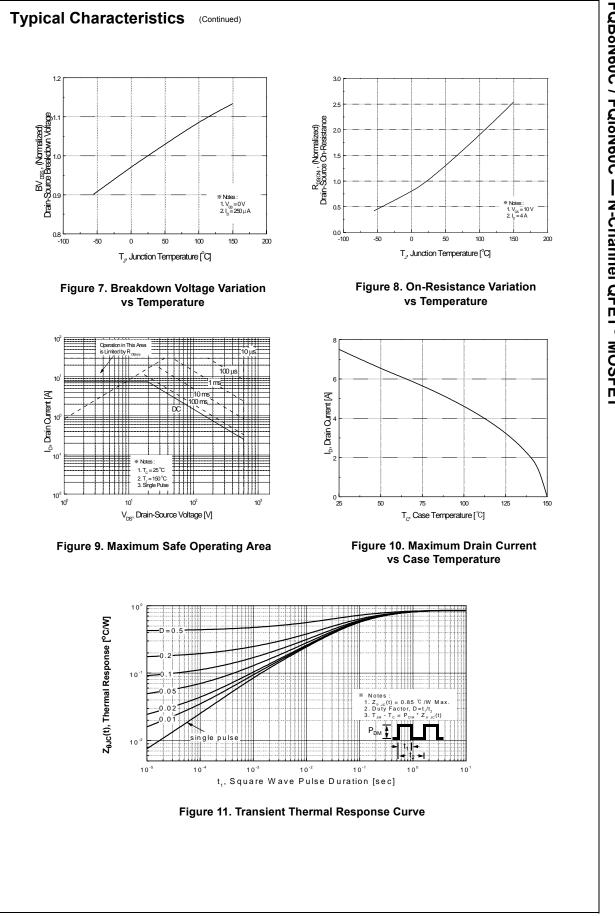
Symbol	Parameter	FQB8N60CTM / FQI8N60CTU	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.85		
D	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	40		

FQB8N60CTM FQB8N60C D ² -		Top Mark	Pack	kage Packing Method R		Reel	Size	Tape Width		Quantity	
		FQB8N60C	D²-F	PAK	Tape and Reel	330	mm	24 mm		800 units	
		AK Tube N			A	N/A		50 units			
lectri	cal Cha	racteristics	T _C = 25°0	C unless ot	herwise noted.						
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit	
Off Cha	racterist	ics									
BV _{DSS}	1	rce Breakdown Volt	ade	V _{GS} = 0 V, I _D = 250 μA			600			V	
ABV _{DSS}	Breakdown Voltage Temperature Coefficient		$I_D = 250 \ \mu$ A, Referenced to 25°C								
$/\Delta T_J$							0.7		V/°C		
DSS	Zero Gate Voltage Drain Current		V _{DS} = 600 V, V _{GS} = 0 V					1	μΑ		
			V _{DS} = 480 V, T _C = 125°C					10	μA		
GSSF	Gate-Body	/ Leakage Current,	e Current, Forward $V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$		30 V, V _{DS} = 0 V				100	nA	
GSSR	Gate-Body Leakage Current, Reverse		V _{GS} = -30 V, V _{DS} = 0 V					-100	nA		
0m 04 -											
	coto Thro			V	V _{GS} , I _D = 250 μA		2.0		4.0	V	
V _{GS(th)}	Static Drai	shold Voltage					2.0		4.0	V	
R _{DS(on)}	On-Resist			V_{GS} = 10 V, I _D = 3.75 A			1.0	1.2	Ω		
9 _{FS}		ransconductance		V _{DS} =	40 V, I _D = 3.75 A			8.7		S	
Dynam	ic Charac	teristics		1				1			
C _{iss}	Input Capa			V _{DS} =	25 V, V _{GS} = 0 V,			965	1255		
C _{oss}	Output Ca	•		f = 1.0	f = 1.0 MHz			105	135	pF	
C _{rss}	Reverse T	ransfer Capacitance	e					12	16	pF	
Switchi	ng Chara	cteristics									
t _{d(on)}	Turn-On D				0001/1 7.54			16.5	45	ns	
r	Turn-On R	,			$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 7.5\text{A},$ $R_{G} = 25 \Omega$			60.5	130	ns	
d(off)	Turn-Off D	elay Time		$\kappa_{\rm G} = 4$	20 12			81	170	ns	
f	Turn-Off F	all Time		1		(Note 4)		64.5	140	ns	
Qg	Total Gate	Charge		Vpc =	480 V, I _D = 7.5A,			28	36	nC	
Q _{gs}	Gate-Sour	ce Charge		V _{GS} = 10 V				4.5		nC	
Q _{gd}	Gate-Drain	n Charge				(Note 4)		12		nC	
	1			1				1		1	
Drain-S	1				ximum Ratings						
s	Maximum	Continuous Drain-S	ource Dic	ode Forv	vard Current				7.5	A	
SM	Maximum	Pulsed Drain-Source	e Diode F					30	A		
√ _{SD}	Drain-Sou	rce Diode Forward	Voltage		0 V, I _S = 7.5 A				1.4	V	
rr		ecovery Time			0 V, I _S = 7.5 A,			365		ns	
Q _{rr}	Reverse R	lecovery Charge		dl _F /d	t = 100 A/μs			3.4		μC	

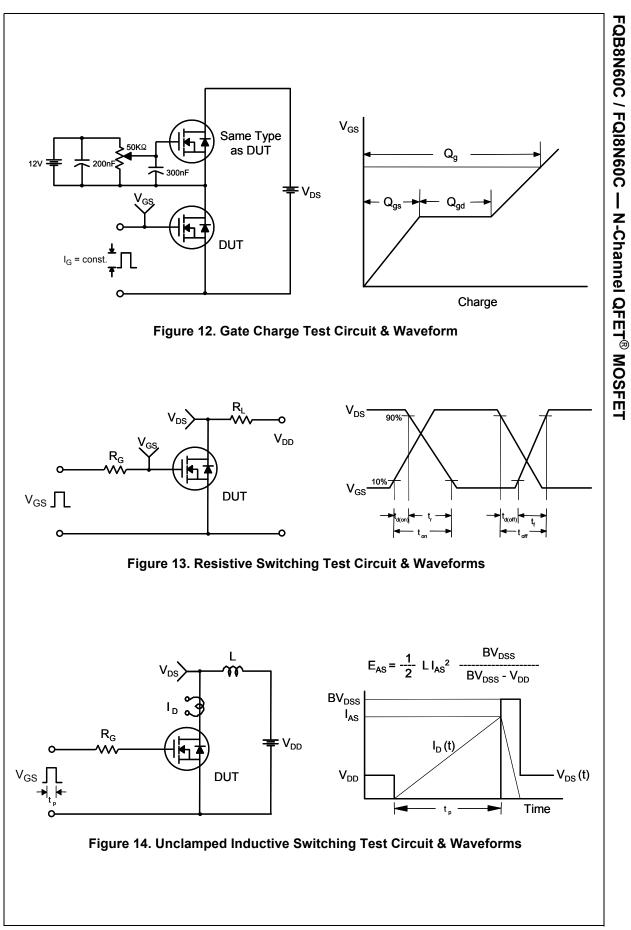
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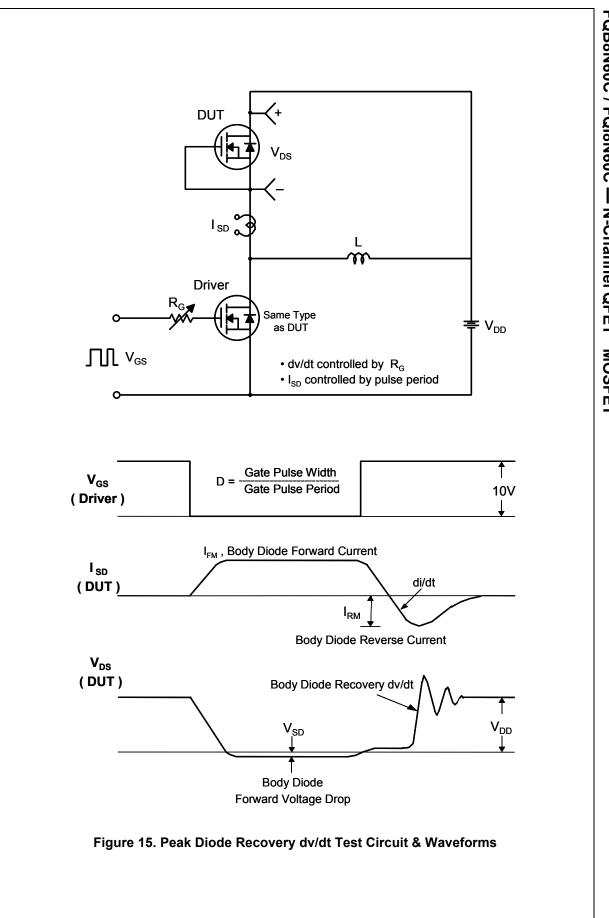
 $3.I_{SD} \le 7.5$ A, di/dt ≤ 200 A/µs , V_{DD} $\le BV_{DSS}$ startin 4. Essentially independent of operating temperature.



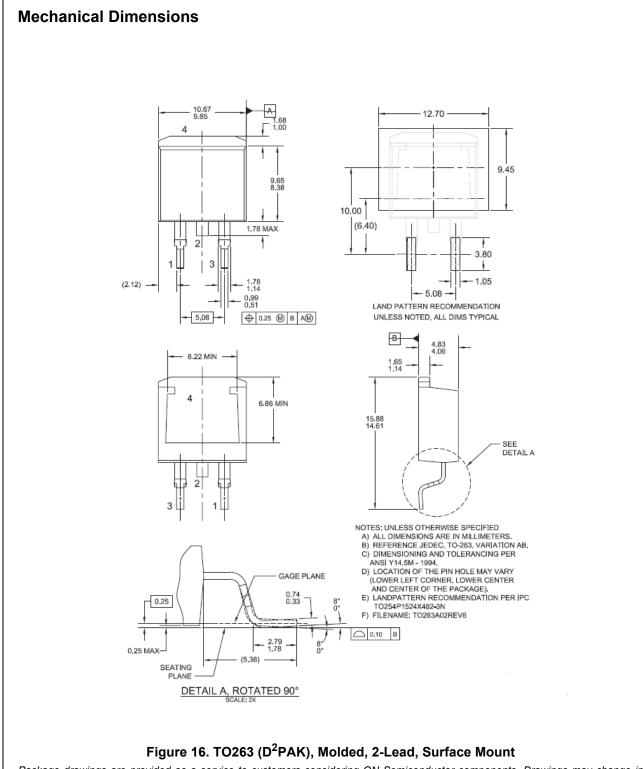


FQB8N60C / FQI8N60C — N-Channel QFET[®] MOSFET





FQB8N60C / FQI8N60C — N-Channel QFET[®] MOSFET



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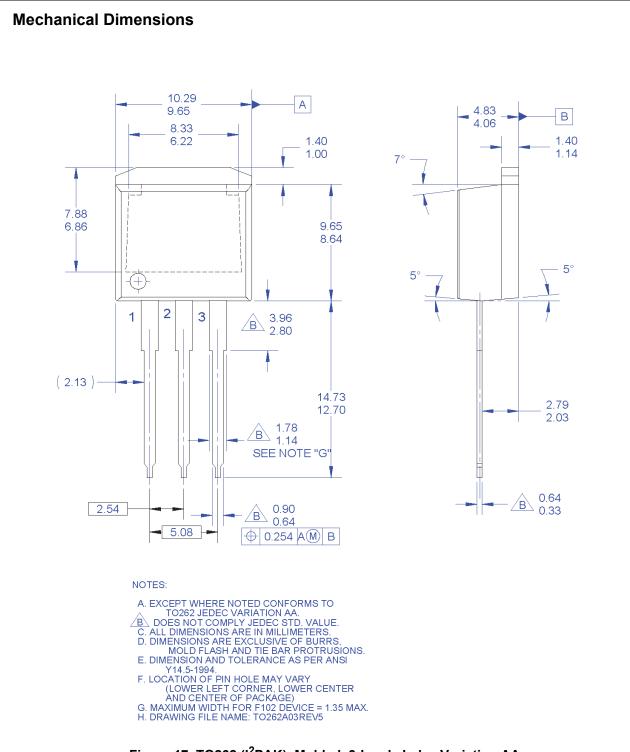


Figure 17. TO262 (I²PAK), Molded, 3-Lead, Jedec Variation AA

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